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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


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Fast Recovery
Epitaxial Diode (FRED)

| $V_{\text {RSM }}$ | $V_{\text {RRM }}$ | Type |
| :--- | :---: | :--- |
| $V$ | $V$ |  |
| 1200 | 1200 | DSEI 30-12A |



A = Anode,$C=$ Cathode

## Features

- International standard package JEDEC TO-247 AD
- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- Low $\mathrm{I}_{\mathrm{RM}}$-values
- Soft recovery behaviour
- Epoxy meets UL 94V-0


## Applications

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders


## Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses
- Operating at lower temperature or space saving by reduced cooling

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Fig. 1 Forward current versus voltage drop.


Fig. 4 Dynamic parameters versus junction temperature.


Fig. 2 Recovery charge versus -di $/ \mathrm{dt}$.


Fig. 5 Recovery time versus -di $/ \mathrm{dt}$.


Fig. 3 Peak reverse current versus $-d i_{F} / d t$.


Fig. 6 Peak forward voltage versus di/ /dt.


Fig. 7 Transient thermal impedance junction to case.

| Dim. | Millimeter |  | Inches |  |
| :--- | ---: | ---: | :--- | ---: |
|  | Min. | Max. | Min. | Max. |
| A | 19.81 | 20.32 | 0.780 | 0.800 |
| B | 20.80 | 21.46 | 0.819 | 0.845 |
| C | 15.75 | 16.26 | 0.610 | 0.640 |
| D | 3.55 | 3.65 | 0.140 | 0.144 |
| E | 4.32 | 5.49 | 0.170 | 0.216 |
| F | 5.4 | 6.2 | 0.212 | 0.244 |
| G | 1.65 | 2.13 | 0.065 | 0.084 |
| H | - | 4.5 | - | 0.177 |
| J | 1.0 | 1.4 | 0.040 | 0.055 |
| K | 10.8 | 11.0 | 0.426 | 0.433 |
| L | 4.7 | 5.3 | 0.185 | 0.209 |
| M | 0.4 | 0.8 | 0.016 | 0.031 |
| N | 2.2 | 2.54 | 0.087 | 0.102 |




[^0]:    (1) $I_{\text {FAVM }}$ rating includes reverse blocking losses at $T_{\text {VJM }}, V_{R}=0.8 \mathrm{~V}_{\text {RRM }}$, duty cycle $\mathrm{d}=0.5$

    Data according to IEC 60747
    IXYS reserves the right to change limits, test conditions and dimensions

